



RECOMMENDED PCB LAYOUT
PCB图仅供参考

Note:

1.Material:

- 1.1 Housing: High temperature thermoplastic with g.f,UL94v-0
- 1.2 Contact: copper alloy,t=0.15mm
- 1.3 Shell: copper alloy,t=0.25mm

2.Specification:

- 2.1 Current rating:1,5PIN 1.8A Max/2,3,4PIN 1A Max.
- 2.2 Dielectric withstanding voltage: 100 V(ac) for 1 min.
- 2.3 Contact resistance: 30 mΩ Max.
- 2.4 Insulation resistance: 100 MΩ Min.
- 2.5 Total mating force: 3.57 Kgf Max.
- 2.6 Total unmating force: 1.0 Kgf Min.
- 2.7 Temperature range: -30°C~80°C

A 01 S B X X X X X XX-059

① ② ③ ④ ⑤ ⑥ ⑦ ⑧ ⑨ ⑩ ⑪

外壳材质
1:G2880R-H

外壳电镀
1:Ni50μ'
2:露T50μ'
3:W-Au1μ' (D)
4:Au1μ'

端子电镀 01:Au1μ';02:Au1.5μ';03:Au3μ'
05:Au5μ';10:Au10μ';15:Au15μ';30:Au30μ'

主体颜色 B:黑色
主体材质 1:LCP
端子材质 4:G5191R-BH

2016.2.5

MODEL NO: XX

UNIT: MM SIZE: A4

TOLERANCE UNSPECIFIED
.x 0.15
.xx 0.10
.xxx 0.05
Ang. 1°

MATERIAL: SEE NOTE

FINISH: SEE NOTE

COLOR: SEE NOTE

DR: 陈雅

CHK: 洪章波

APP: 魏杰

深圳市裕诚电子有限公司
SHENZHEN YUCHENG ELECTRONICS CO., LTD

TITLE:
Micro usb 5s B Type 板式1.17 Smp 脚全贴

DWG NO: MICRO-4C69-J

www.ycelectron.com

REV: A

